

# ATP Industrial Grade Endura Specification

Revision 1.4



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**Revision History**

Date	Version	Changes compared to previous issue
Dec. 16 <sup>th</sup> , 2011	1.0	- 1 <sup>st</sup> version
Feb. 8 <sup>th</sup> , 2012	1.1	- Revised dimensions
May. 22 <sup>nd</sup> , 2012	1.2	- Add 8GB product
Aug. 3 <sup>rd</sup> , 2012	1.3	- Revised 2GB P/N and Performance
Aug. 20 <sup>th</sup> , 2012	1.4	- Revised 512MB P/N and Performance

## Images



*\*Laser engraving logo and letters.*

## Capacities

ATP UFD P/N	CAPACITY	COLOR
AF512UFEDBK(I)-AABXX	512MB	Black
AF1GUFEDBK(I)-8AAXX	1GB	Black
AF2GUFEDBK(I)- JABXX	2GB	Black
AF4GUFEDBK(I)-JABXX	4GB	Black
AF8GUFEDBK(I)-9AAXX	8GB	Black

## Features

USB Interface	UFD Feature
<ul style="list-style-type: none"> <li>High Speed USB 2.0 (480Mbps) compliant and backward compatible with USB1.1 (12Mbps)</li> <li>True “Plug and play” connection support hot swap.</li> </ul>	<ul style="list-style-type: none"> <li>SIP technology with SLC NAND Flash</li> <li>Color - Black</li> </ul>

System Support
<ul style="list-style-type: none"> <li>No driver needed for Windows 7 / Vista / 2000 / ME / XP, Mac. OS 9.x or above. Linux Kernel 2.4.0 or above</li> <li>Device driver is needed for Windows 98SE</li> </ul>

*Your Ultimate Memory Solution!*



## **Electrical Specifications**

Symbol	Parameter	Min.	Typ.	Max.	Unit
Vcc	Recommend Supply Voltage	4.5	5.0	5.5	V
Vpeak	Peak Voltage on any pin	-0.3		5.5	V
Icc	Operating Current (read & write)		100		mA
Isb	Standby Current		50		mA

## **Environment Specifications:**

Parameter		Value
Temperature	Operating	-40°C to 85°C
	Non-Operating	-40°C to 85°C
Humidity	Operating	25 °C, 95% RH
	Non-Operating	40 °C, 93% RH
ESD (IEC61000-4-2)	Non contact pads	+/- 15KV ( Air discharge )
	Contact pads	+/- 8KV (Coupling plane discharge)
	Contact pads	+/- 4KV
Salt Water Spray	Non-Operating	3%NaCl/35, Over 85%RH, 24hours
Drop Test	Non-Operating	150cm/free fall, total 6 drops
Random Vibration	Non-Operating	10~2000Hz, 6 Grms, 30 mins per axis
UV Light Exposure Test	Non-Operating	254nm, 15Ws/cm2

## **Reliability:**

MTBF@25°C: >5,000,000 hours (Telcordia/Bellcore SR-332)

Dynamic and Static wear leveling algorithm to improve the endurance

Endurance : SLC flash block >60,000 Program/Erase cycles

**Performance:**

Type	Parameter	Value
512MB	Sequential read	up to 18MByte/s
	Sequential write	up to 12MByte/s
1GB	Sequential read	up to 35MByte/s
	Sequential write	up to 17MByte/s
2GB	Sequential read	up to 31MByte/s
	Sequential write	up to 14MByte/s
4GB	Sequential read	up to 33MByte/s
	Sequential write	up to 22MByte/s
8GB	Sequential read	up to 20MByte/s
	Sequential write	up to 19MByte/s

**Extra Features:**

Type	Value
Water Proof	Yes
Dust Proof	Yes
ESD Proof	Yes
Shock Resistant	Yes

**Certifications**

- RoHS compliant
- CE certification
- FCC certification

**Physical Dimension Specifications (Units in MM):**

Type	Value
Length*	33.7mm +/- 0.3mm
Width	17.5mm +/- 0.25mm
Thickness	9.4mm +/- 0.25mm
Weight*	8 g Max.

**Mechanical Form Factor (Units in MM)**